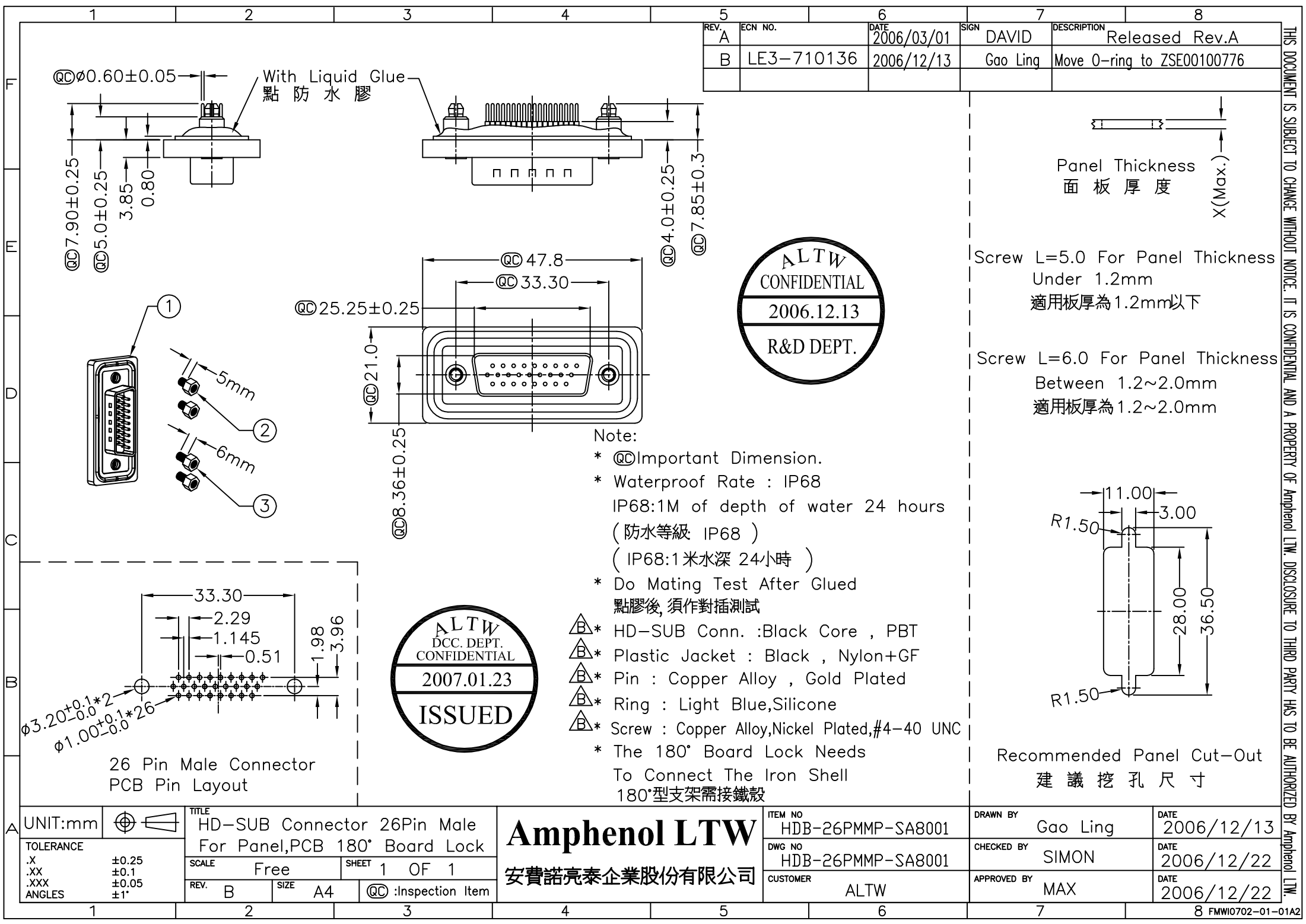


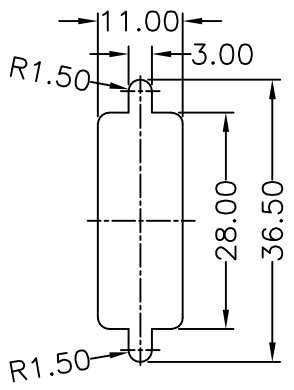


REV.	ECN NO.	DATE	SIGN	DESCRIPTION
A		2006/03/01	DAVID	Released Rev.A
B	LE3-710136	2006/12/13	Gao Ling	Move O-ring to ZSE00100776

Panel Thickness
面板厚度
X(Max.)

Screw L=5.0 For Panel Thickness
Under 1.2mm
適用板厚為1.2mm以下

Screw L=6.0 For Panel Thickness
Between 1.2~2.0mm
適用板厚為1.2~2.0mm



Recommended Panel Cut-Out
建議挖孔尺寸

UNIT:mm		TITLE HD-SUB Connector 26Pin Male For Panel,PCB 180° Board Lock
TOLERANCE .X ±0.25 .XX ±0.1 .XXX ±0.05 ANGLES ±1°	SCALE Free	SHEET 1 OF 1
REV. B	SIZE A4	@C :Inspection Item

Amphenol LTW
安費諾亮泰企業股份有限公司

ITEM NO HDB-26PMMP-SA8001
DWG NO HDB-26PMMP-SA8001
CUSTOMER ALTW

DRAWN BY Gao Ling	DATE 2006/12/13
CHECKED BY SIMON	DATE 2006/12/22
APPROVED BY MAX	DATE 2006/12/22

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